

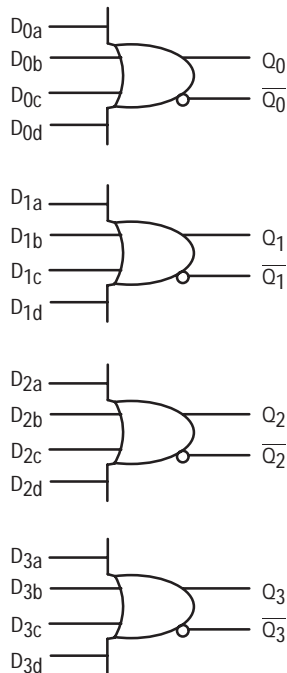
MC10EP101

Quad 4-Input OR/NOR

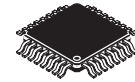
The MC10EP101 is a Quad 4-input OR/NOR gate. The device is functionally equivalent to the E101. With AC performance faster than the E101 device, the EP101 is ideal for applications requiring the fastest AC performance available. All VCC and VEE pins must be externally connected to power supply to guarantee proper operation.

- 250ps Typical Propagation Delay
 - High Bandwidth to 3 Ghz Typical
 - PECL mode: 3.0V to 5.5V VCC with VEE = 0V
 - ECL mode: 0V VCC with VEE = -3.0V to -5.5V
 - 75kΩ Internal Input Pulldown Resistors
 - ESD Protection: >4KV HBM, >100V MM
 - Moisture Sensitivity Level 2
- For Additional Information, See Application Note AND8003/D
- Flammability Rating: UL-94 code V-0 @ 1/8", Oxygen Index 28 to 34
 - Transistor Count = 173 devices

LOGIC DIAGRAM

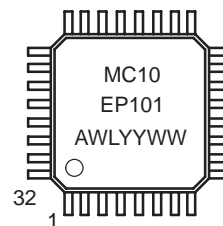


ON Semiconductor
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32-LEAD TQFP
FA SUFFIX
CASE 873A

MARKING DIAGRAM*



A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week

*For additional information, see Application Note AND8002/D

PIN DESCRIPTION

PIN	FUNCTION
D0a–D3d	ECL Data Inputs
Q0–Q3, Q0–Q3	ECL Data Outputs
VCC	Positive Supply
VBB	Reference Voltage Output
VEE	Negative, 0 Supply

TRUTH TABLE

Dna	Dnb	Dnc	Dnd	Qn	Qn
L	L	L	L	L	H
H	X	X	X	H	L
X	H	X	X	H	L
X	X	H	X	H	L
X	X	X	H	H	L
H	H	H	H	H	L

ORDERING INFORMATION

Device	Package	Shipping
MC10EP101FA	TQFP	250 Units/Tray
MC10EP101FAR2	TQFP	2000 Tape & Reel

MC10EP101

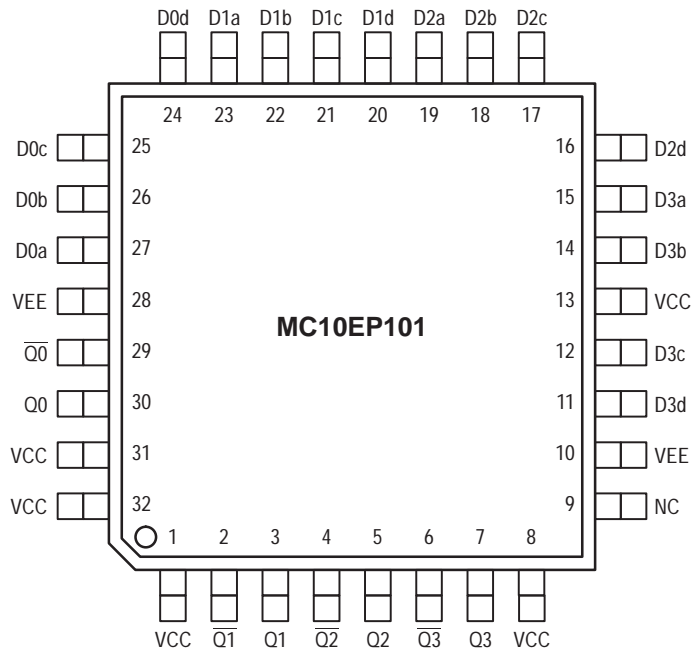


Figure 1. 32-Lead TQFP Pinout
(Top View)

Warning: All V_{CC} and V_{EE} pins must be externally connected to Power Supply to guarantee proper operation.

MAXIMUM RATINGS*

Symbol	Parameter	Value	Unit	
V_{EE}	Power Supply ($V_{CC} = 0V$)	-6.0 to 0	VDC	
V_{CC}	Power Supply ($V_{EE} = 0V$)	6.0 to 0	VDC	
V_I	Input Voltage ($V_{CC} = 0V$, V_I not more negative than V_{EE})	-6.0 to 0	VDC	
V_I	Input Voltage ($V_{EE} = 0V$, V_I not more positive than V_{CC})	6.0 to 0	VDC	
I_{out}	Output Current	Continuous Surge	50 100	mA
T_A	Operating Temperature Range	-40 to +85	°C	
T_{stg}	Storage Temperature	-65 to +150	°C	
θ_{JA}	Thermal Resistance (Junction-to-Ambient)	Still Air 500lfpm	80 55	°C/W
θ_{JC}	Thermal Resistance (Junction-to-Case)	12 to 17	°C/W	
T_{sol}	Solder Temperature (<2 to 3 Seconds: 245°C desired)	265	°C	

* Maximum Ratings are those values beyond which damage to the device may occur.

MC10EP101

DC CHARACTERISTICS, ECL/LVECL ($V_{CC} = 0V$, $V_{EE} = -5.5V$ to $-3.0V$) (Note 3.)

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
IEE	Power Supply Current (Note 1.)	45	57	75	45	58	75	45	59	75	mA
VOH	Output HIGH Voltage (Note 2.)	-1135	-1060	-885	-1070	-945	-820	-1010	-885	-760	mV
VOL	Output LOW Voltage (Note 2.)	-1995	-1810	-1685	-1995	-1745	-1620	-1995	-1685	-1560	mV
VIH	Input HIGH Voltage Single Ended	-1210		-885	-1145		-820	-1085		-760	mV
VIL	Input LOW Voltage Single Ended	-1935		-1610	-1870		-1545	-1810		-1485	mV
I _{IH}	Input HIGH Current			150			150			150	μA
I _{IL}	Input LOW Current	-150			-150			-150			μA

NOTE: 10EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500lfpm is maintained.

1. $V_{CC} = 0V$, $V_{EE} = V_{EEmin}$ to V_{EEmax} , all other pins floating.
2. All loading with 50 ohms to $V_{CC} - 2.0$ volts.
3. Input and output parameters vary 1:1 with V_{CC} .

DC CHARACTERISTICS, LVPECL ($V_{CC} = 3.3V \pm 0.3V$, $V_{EE} = 0V$) (Note 6.)

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
IEE	Power Supply Current (Note 4.)	45	57	75	45	58	75	45	59	75	mA
VOH	Output HIGH Voltage (Note 5.)	2165	2240	2415	2230	2355	2480	2290	2415	2540	mV
VOL	Output LOW Voltage (Note 5.)	1305	1490	1615	1305	1555	1680	1305	1615	1740	mV
VIH	Input HIGH Voltage Single Ended	2090		2415	2155		2480	2215		2540	mV
VIL	Input LOW Voltage Single Ended	1365		1690	1430		1755	1490		1815	mV
I _{IH}	Input HIGH Current			150			150			150	μA
I _{IL}	Input LOW Current	-150			-150			-150			μA

NOTE: 10EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500lfpm is maintained.

4. $V_{CC} = 3.0V$, $V_{EE} = 0V$, all other pins floating.
5. All loading with 50 ohms to $V_{CC} - 2.0$ volts.
6. Input and output parameters vary 1:1 with V_{CC} .

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DC CHARACTERISTICS, PECL ($V_{CC} = 5.0V \pm 0.5V$, $V_{EE} = 0V$) (Note 9.)

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
IEE	Power Supply Current (Note 7.)	45	57	75	45	58	75	45	59	75	mA
VOH	Output HIGH Voltage (Note 8.)	3865	3940	4115	3930	4055	4180	3990	4115	4240	mV
VOL	Output LOW Voltage (Note 8.)	3005	3190	3315	3005	3255	3380	3005	3315	3440	mV
VIH	Input HIGH Voltage Single Ended	3790		4115	3855		4180	3915		4240	mV
VIL	Input LOW Voltage Single Ended	3065		3390	3130		3455	3190		3515	mV
I _{IH}	Input HIGH Current			150			150			150	μA
I _{IL}	Input LOW Current	-150			-150			-150			μA

NOTE: 10EP circuits are designed to meet the DC specifications shown in the above table after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse airflow greater than 500lfpm is maintained.

7. $V_{CC} = 5.0V$, $V_{EE} = 0V$, all other pins floating.

8. All loading with 50 ohms to $V_{CC} - 2.0$ volts.

9. Input and output parameters vary 1:1 with V_{CC} .

AC CHARACTERISTICS ($V_{CC} = 3.0V$ to $5.5V$; $V_{EE} = 0V$) or ($V_{CC} = 0V$; $V_{EE} = -3.0V$ to $-5.5V$)

Symbol	Characteristic	-40°C			25°C			85°C			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
f _{max}	Maximum Toggle Frequency (Note 10.)		3.0			3.0			3.0		GHz
t _{PLH} , t _{PHL}	Propagation Delay D → Q, \bar{Q}	125	225	325	150	250	370	170	300	420	ps
t _{SKEW}	Device Skew Part-to-Part (Note 11.) Q, \bar{Q}		TBD TBD			TBD TBD			TBD TBD		ps
t _{JITTER}	Cycle-to-Cycle Jitter		TBD			TBD			TBD		ps
t _r , t _f	Output Rise and Fall Times (20% – 80%) Q, \bar{Q}	100	150	200	100	170	250	120	190	270	ps

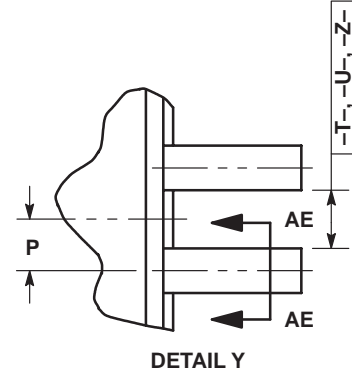
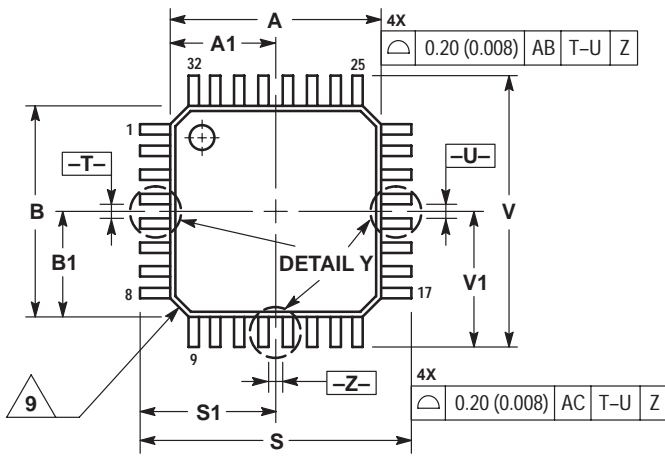
10. F_{max} guaranteed for functionality only.

11. Skew is measured between outputs under identical transitions.

MC10EP101

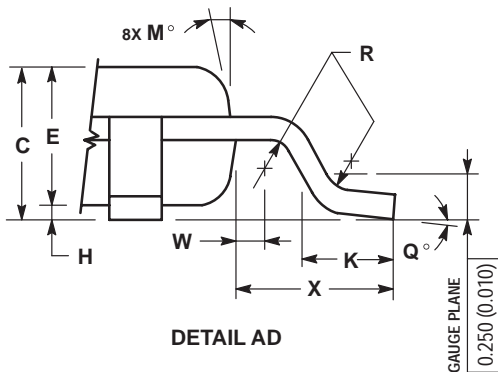
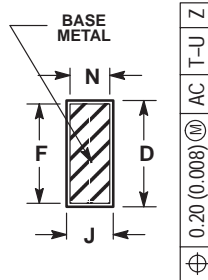
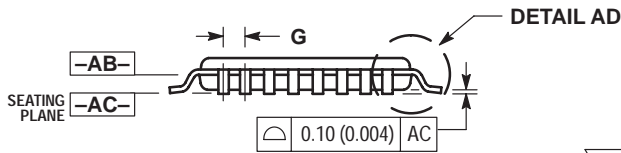
PACKAGE DIMENSIONS

TQFP
FA SUFFIX
32-LEAD PLASTIC PACKAGE
CASE 873A-02
ISSUE A



NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DATUM PLANE -AB- IS LOCATED AT BOTTOM OF LEAD AND IS COINCIDENT WITH THE LEAD WHERE THE LEAD EXITS THE PLASTIC BODY AT THE BOTTOM OF THE PARTING LINE.
4. DATUMS -T-, -U-, AND -Z- TO BE DETERMINED AT DATUM PLANE -AB-.
5. DIMENSIONS S AND V TO BE DETERMINED AT SEATING PLANE -AC-.
6. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION. ALLOWABLE PROTRUSION IS 0.250 (0.010) PER SIDE. DIMENSIONS A AND B DO INCLUDE MOLD MISMATCH AND ARE DETERMINED AT DATUM PLANE -AB-.
7. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. DAMBAR PROTRUSION SHALL NOT CAUSE THE D DIMENSION TO EXCEED 0.520 (0.020).
8. MINIMUM SOLDER PLATE THICKNESS SHALL BE 0.0076 (0.0003).
9. EXACT SHAPE OF EACH CORNER MAY VARY FROM DEPICTION.



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	7.000	BSC	0.276	BSC
A1	3.500	BSC	0.138	BSC
B	7.000	BSC	0.276	BSC
B1	3.500	BSC	0.138	BSC
C	1.400	1.600	0.055	0.063
D	0.300	0.450	0.012	0.018
E	1.350	1.450	0.053	0.057
F	0.300	0.400	0.012	0.016
G	0.800	BSC	0.031	BSC
H	0.050	0.150	0.002	0.006
J	0.090	0.200	0.004	0.008
K	0.500	0.700	0.020	0.028
M	12°	REF	12°	REF
N	0.090	0.160	0.004	0.006
P	0.400	BSC	0.016	BSC
Q	1°	5°	1°	5°
R	0.150	0.250	0.006	0.010
S	9.000	BSC	0.354	BSC
S1	4.500	BSC	0.177	BSC
V	9.000	BSC	0.354	BSC
V1	4.500	BSC	0.177	BSC
W	0.200	REF	0.008	REF
X	1.000	REF	0.039	REF

Notes

Notes

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